

Embedded Non-Volatile Memory (eNVM) Market Forecasts to 2034 – Global Analysis By Memory Type (Embedded Flash, Embedded EEPROM, Embedded MRAM, Embedded ReRAM, Embedded FRAM, Embedded PCM, Embedded OTP, and Other Emerging eNVM Technologies), Process Node, Technology, Application, End User and By Geography

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Abstracts

According to Statistics MRC, the Global Embedded Non-Volatile Memory (eNVM) Market is accounted for \$5.6 billion in 2026 and is expected to reach \$10.5 billion by 2034, growing at a CAGR of 8.2% during the forecast period. Embedded non-volatile memory refers to memory technologies integrated directly onto semiconductor chips alongside logic circuits, enabling data retention without power consumption and offering advantages in performance, power efficiency, security, and system integration compared to external memory solutions. This memory encompasses various types including embedded flash, embedded EEPROM, embedded MRAM, embedded ReRAM, embedded FRAM, embedded PCM, embedded OTP, and other emerging eNVM technologies across process nodes ranging from above 65 nm to below 16 nm.

Market Dynamics:

Driver:

Growing demand for IoT, edge computing, and secure microcontrollers

The rapid expansion of IoT devices, edge computing applications, and the increasing demand for secure microcontrollers serve as primary catalysts for the embedded non-

volatile memory market. IoT devices require on-chip memory for code storage, data logging, and security features while maintaining low power consumption and small form factors. Edge computing applications need fast, reliable non-volatile memory for local data processing and model storage. The growing focus on device security drives adoption of eNVM for secure key storage and cryptographic functions. As IoT and edge computing continue to grow, the demand for eNVM solutions continues to accelerate.

Restraint:

High integration complexity and manufacturing costs

The embedded non-volatile memory market faces significant challenges from high integration complexity and manufacturing costs that can limit adoption. Integrating eNVM with advanced logic processes requires additional processing steps, specialized materials, and careful process integration. The development of eNVM for advanced process nodes involves substantial research and development investment to achieve reliable performance and yield. Additionally, the migration to new eNVM technologies requires significant development efforts to achieve manufacturing maturity. These integration and cost challenges can limit eNVM adoption, particularly in cost-sensitive applications and smaller manufacturers.

Opportunity:

Advancements in emerging memory technologies

The development of emerging memory technologies, including MRAM, ReRAM, and PCM, presents significant opportunities for the embedded non-volatile memory market. Emerging memories offer advantages over traditional flash including better performance, lower power consumption, and compatibility with advanced process nodes. The ability to integrate emerging memories with advanced logic processes enables new applications and system architectures. The growing adoption of emerging memories for automotive, industrial, and AI applications creates substantial growth opportunities. As emerging technologies mature, the demand for advanced eNVM solutions continues to expand.

Threat:

Competition from external memory solutions and alternative technologies

The embedded non-volatile memory market faces threats from competition from external memory solutions and alternative technologies that could reduce demand for eNVM. Advances in external flash and other memory technologies could narrow the performance and cost advantages of embedded solutions. Additionally, emerging architectures including processing-in-memory could change system memory requirements. The development of new memory technologies not compatible with CMOS integration could create competitive pressure for eNVM. These competitive threats require continuous innovation and cost reduction.

Covid-19 Impact:

The COVID-19 pandemic significantly impacted the embedded non-volatile memory market by accelerating demand for IoT, edge computing, and connected devices while disrupting semiconductor supply chains and production schedules. The shift toward remote work and digital services increased demand for smart devices, secure MCUs, and edge computing solutions, supporting eNVM adoption. Supply chain disruptions affected specialized materials and component availability. The semiconductor industry's response to increased demand and supply challenges supported continued eNVM development and deployment. As digital transformation accelerated, the focus on secure, power-efficient memory solutions intensified.

The embedded flash segment is expected to be the largest during the forecast period

The embedded flash segment is expected to account for the largest market share during the forecast period, driven by its established maturity, wide availability, cost-effectiveness, and widespread adoption across applications including microcontrollers, secure ICs, and automotive electronics. Embedded flash provides reliable non-volatile storage for code and data with proven manufacturing processes. As the most mature eNVM technology, embedded flash maintains the largest market share across diverse applications.

The embedded MRAM segment is expected to have the highest CAGR during the forecast period

Over the forecast period, the embedded MRAM segment is predicted to witness the highest growth rate, driven by its superior performance characteristics including high speed, low power consumption, endurance, and scalability to advanced process nodes, making it suitable for applications requiring frequent writes and fast data access. MRAM offers advantages over flash for applications requiring high endurance and fast write

operations. As MRAM technology matures and manufacturing capacity expands, adoption continues to accelerate.

Region with largest share:

During the forecast period, the Asia Pacific region is expected to hold the largest market share, driven by the concentration of semiconductor manufacturing capacity, presence of leading foundries and memory manufacturers, significant investment in advanced process technology, and strong demand from IoT and consumer electronics markets across countries like Taiwan, South Korea, China, Japan, and Singapore. The region's dominance in semiconductor manufacturing supports eNVM market leadership. Additionally, the concentration of electronics manufacturing and IoT device production contributes to the region's largest market share.

Region with highest CAGR:

Over the forecast period, the Asia Pacific region is also anticipated to exhibit the highest CAGR, reinforcing its market leadership through continued investment in semiconductor manufacturing and advanced process technologies. The growth is fueled by increasing demand for eNVM in IoT devices, automotive electronics, consumer electronics, and industrial applications across Asia Pacific countries. The rapid expansion of IoT device production and automotive electronics manufacturing across the region accelerates eNVM adoption at the fastest pace.

Key players in the market

Some of the key players in Embedded Non-Volatile Memory (eNVM) Market include Samsung Electronics Co. Ltd., Taiwan Semiconductor Manufacturing Company (TSMC), GlobalFoundries Inc., United Microelectronics Corporation (UMC), Semiconductor Manufacturing International Corporation (SMIC), Intel Corporation, Infineon Technologies AG, STMicroelectronics N.V., Renesas Electronics Corporation, Texas Instruments Incorporated, NXP Semiconductors N.V., Microchip Technology Inc., onsemi, Weebit Nano Ltd., and Winbond Electronics Corporation.

Key Developments:

In March 2025, TSMC announced its next-generation embedded MRAM technology for advanced process nodes, delivering improved performance and power efficiency for AI and edge computing applications. The technology enables high-speed, non-volatile

memory integration with logic.

In February 2025, Samsung Electronics introduced a new embedded non-volatile memory solution for automotive and industrial applications featuring enhanced reliability and endurance. The solution addresses demanding requirements for safety-critical and industrial applications.

Memory Types Covered:

Embedded Flash

Embedded EEPROM

Embedded MRAM

Embedded ReRAM

Embedded FRAM

Embedded PCM

Embedded OTP

Other Emerging eNVM Technologies

Process Nodes Covered:

Above 65 nm

40–65 nm

28–39 nm

16–22 nm

Below 16 nm

Technologies Covered:

CMOS-Based eNVM

FinFET-Based eNVM

FD-SOI-Based eNVM

Silicon-on-Insulator (SOI)-Based eNVM

AI-Optimized Memory Technologies

Applications Covered:

Microcontrollers (MCUs)

System-on-Chip (SoC)

ASICs

FPGAs

Secure ICs

Power Management ICs (PMICs)

AI & Edge Computing Chips

IoT Devices

Automotive Electronics

Consumer Electronics

Industrial Electronics

End Users Covered:

Semiconductor Manufacturers

Automotive OEMs

Consumer Electronics Manufacturers

Industrial Equipment Manufacturers

Healthcare Device Manufacturers

Aerospace & Defense Organizations

Telecommunications Equipment Manufacturers

Regions Covered:

North America

United States

Canada

Mexico

Europe

United Kingdom

Germany

France

Italy

Spain

Netherlands

Belgium

Sweden

Switzerland

Poland

Rest of Europe

Asia Pacific

China

Japan

India

South Korea

Australia

Indonesia

Thailand

Malaysia

Singapore

Vietnam

Rest of Asia Pacific

South America

Brazil

Argentina

Colombia

Chile

Peru

Rest of South America

Rest of the World (RoW)

Middle East

Saudi Arabia

United Arab Emirates

Qatar

Israel

Rest of Middle East

Africa

South Africa

Egypt

Morocco

Rest of Africa

What our report offers:

Market share assessments for the regional and country-level segments

Strategic recommendations for the new entrants

Covers Market data for the years 2023, 2024, 2025, 2026, 2027, 2028, 2030, 2032 and 2034

Market Trends (Drivers, Constraints, Opportunities, Threats, Challenges, Investment Opportunities, and recommendations)

Strategic recommendations in key business segments based on the market estimations

Competitive landscaping mapping the key common trends

Company profiling with detailed strategies, financials, and recent developments

Supply chain trends mapping the latest technological advancements

Free Customization Offerings:

All the customers of this report will be entitled to receive one of the following free customization options:

Company Profiling

Comprehensive profiling of additional market players (up to 3)

SWOT Analysis of key players (up to 3)

Regional Segmentation

Market estimations, Forecasts and CAGR of any prominent country as per the client's interest (Note: Depends on feasibility check)

Competitive Benchmarking

Benchmarking of key players based on product portfolio, geographical presence, and strategic alliances

Contents

1 EXECUTIVE SUMMARY

- 1.1 Market Snapshot and Key Highlights
- 1.2 Growth Drivers, Challenges, and Opportunities
- 1.3 Competitive Landscape Overview
- 1.4 Strategic Insights and Recommendations

2 RESEARCH FRAMEWORK

- 2.1 Study Objectives and Scope
- 2.2 Stakeholder Analysis
- 2.3 Research Assumptions and Limitations
- 2.4 Research Methodology
 - 2.4.1 Data Collection (Primary and Secondary)
 - 2.4.2 Data Modeling and Estimation Techniques
 - 2.4.3 Data Validation and Triangulation
 - 2.4.4 Analytical and Forecasting Approach

3 MARKET DYNAMICS AND TREND ANALYSIS

- 3.1 Market Definition and Structure
- 3.2 Key Market Drivers
- 3.3 Market Restraints and Challenges
- 3.4 Growth Opportunities and Investment Hotspots
- 3.5 Industry Threats and Risk Assessment
- 3.6 Technology and Innovation Landscape
- 3.7 Emerging and High-Growth Markets
- 3.8 Regulatory and Policy Environment
- 3.9 Impact of COVID-19 and Recovery Outlook

4 COMPETITIVE AND STRATEGIC ASSESSMENT

- 4.1 Porter's Five Forces Analysis
 - 4.1.1 Supplier Bargaining Power
 - 4.1.2 Buyer Bargaining Power
 - 4.1.3 Threat of Substitutes
 - 4.1.4 Threat of New Entrants

- 4.1.5 Competitive Rivalry
- 4.2 Market Share Analysis of Key Players
- 4.3 Product Benchmarking and Performance Comparison

5 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY MEMORY TYPE

- 5.1 Embedded Flash
- 5.2 Embedded EEPROM
- 5.3 Embedded MRAM
- 5.4 Embedded ReRAM
- 5.5 Embedded FRAM
- 5.6 Embedded PCM
- 5.7 Embedded OTP
- 5.8 Other Emerging eNVM Technologies

6 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY PROCESS NODE

- 6.1 Above 65 nm
- 6.2 40–65 nm
- 6.3 28–39 nm
- 6.4 16–22 nm
- 6.5 Below 16 nm

7 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY TECHNOLOGY

- 7.1 CMOS-Based eNVM
- 7.2 FinFET-Based eNVM
- 7.3 FD-SOI-Based eNVM
- 7.4 Silicon-on-Insulator (SOI)-Based eNVM
- 7.5 AI-Optimized Memory Technologies

8 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY APPLICATION

- 8.1 Microcontrollers (MCUs)
- 8.2 System-on-Chip (SoC)

- 8.3 ASICs
- 8.4 FPGAs
- 8.5 Secure ICs
- 8.6 Power Management ICs (PMICs)
- 8.7 AI & Edge Computing Chips
- 8.8 IoT Devices
- 8.9 Automotive Electronics
- 8.10 Consumer Electronics
- 8.11 Industrial Electronics

9 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY END USER

- 9.1 Semiconductor Manufacturers
- 9.2 Automotive OEMs
- 9.3 Consumer Electronics Manufacturers
- 9.4 Industrial Equipment Manufacturers
- 9.5 Healthcare Device Manufacturers
- 9.6 Aerospace & Defense Organizations
- 9.7 Telecommunications Equipment Manufacturers

10 GLOBAL EMBEDDED NON-VOLATILE MEMORY (ENVM) MARKET, BY GEOGRAPHY

- 10.1 North America
 - 10.1.1 United States
 - 10.1.2 Canada
 - 10.1.3 Mexico
- 10.2 Europe
 - 10.2.1 United Kingdom
 - 10.2.2 Germany
 - 10.2.3 France
 - 10.2.4 Italy
 - 10.2.5 Spain
 - 10.2.6 Netherlands
 - 10.2.7 Belgium
 - 10.2.8 Sweden
 - 10.2.9 Switzerland
 - 10.2.10 Poland

10.2.11 Rest of Europe

10.3 Asia Pacific

10.3.1 China

10.3.2 Japan

10.3.3 India

10.3.4 South Korea

10.3.5 Australia

10.3.6 Indonesia

10.3.7 Thailand

10.3.8 Malaysia

10.3.9 Singapore

10.3.10 Vietnam

10.3.11 Rest of Asia Pacific

10.4 South America

10.4.1 Brazil

10.4.2 Argentina

10.4.3 Colombia

10.4.4 Chile

10.4.5 Peru

10.4.6 Rest of South America

10.5 Rest of the World (RoW)

10.5.1 Middle East

10.5.1.1 Saudi Arabia

10.5.1.2 United Arab Emirates

10.5.1.3 Qatar

10.5.1.4 Israel

10.5.1.5 Rest of Middle East

10.5.2 Africa

10.5.2.1 South Africa

10.5.2.2 Egypt

10.5.2.3 Morocco

10.5.2.4 Rest of Africa

11 STRATEGIC MARKET INTELLIGENCE

11.1 Industry Value Network and Supply Chain Assessment

11.2 White-Space and Opportunity Mapping

11.3 Product Evolution and Market Life Cycle Analysis

11.4 Channel, Distributor, and Go-to-Market Assessment

12 INDUSTRY DEVELOPMENTS AND STRATEGIC INITIATIVES

- 12.1 Mergers and Acquisitions
- 12.2 Partnerships, Alliances, and Joint Ventures
- 12.3 New Product Launches and Certifications
- 12.4 Capacity Expansion and Investments
- 12.5 Other Strategic Initiatives

13 COMPANY PROFILES

- 13.1 Samsung Electronics Co., Ltd.
- 13.2 Taiwan Semiconductor Manufacturing Company (TSMC)
- 13.3 GlobalFoundries Inc.
- 13.4 United Microelectronics Corporation (UMC)
- 13.5 Semiconductor Manufacturing International Corporation (SMIC)
- 13.6 Intel Corporation
- 13.7 Infineon Technologies AG
- 13.8 STMicroelectronics N.V.
- 13.9 Renesas Electronics Corporation
- 13.10 Texas Instruments Incorporated
- 13.11 NXP Semiconductors N.V.
- 13.12 Microchip Technology Inc.
- 13.13 onsemi
- 13.14 Weebit Nano Ltd.
- 13.15 Winbond Electronics Corporation

List Of Tables

LIST OF TABLES

Table 1 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Region (2023-2034) (\$MN)

Table 2 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Memory Type (2023-2034) (\$MN)

Table 3 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded Flash (2023-2034) (\$MN)

Table 4 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded EEPROM (2023-2034) (\$MN)

Table 5 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded MRAM (2023-2034) (\$MN)

Table 6 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded ReRAM (2023-2034) (\$MN)

Table 7 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded FRAM (2023-2034) (\$MN)

Table 8 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded PCM (2023-2034) (\$MN)

Table 9 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Embedded OTP (2023-2034) (\$MN)

Table 10 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Other Emerging eNVM Technologies (2023-2034) (\$MN)

Table 11 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Process Node (2023-2034) (\$MN)

Table 12 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Above 65 nm (2023-2034) (\$MN)

Table 13 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By 40–65 nm (2023-2034) (\$MN)

Table 14 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By 28–39 nm (2023-2034) (\$MN)

Table 15 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By 16–22 nm (2023-2034) (\$MN)

Table 16 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Below 16 nm (2023-2034) (\$MN)

Table 17 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Technology (2023-2034) (\$MN)

Table 18 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By CMOS-

Based eNVM (2023-2034) (\$MN)

Table 19 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By FinFET-Based eNVM (2023-2034) (\$MN)

Table 20 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By FD-SOI-Based eNVM (2023-2034) (\$MN)

Table 21 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Silicon-on-Insulator (SOI)-Based eNVM (2023-2034) (\$MN)

Table 22 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By AI-Optimized Memory Technologies (2023-2034) (\$MN)

Table 23 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Application (2023-2034) (\$MN)

Table 24 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Microcontrollers (MCUs) (2023-2034) (\$MN)

Table 25 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By System-on-Chip (SoC) (2023-2034) (\$MN)

Table 26 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By ASICs (2023-2034) (\$MN)

Table 27 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By FPGAs (2023-2034) (\$MN)

Table 28 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Secure ICs (2023-2034) (\$MN)

Table 29 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Power Management ICs (PMICs) (2023-2034) (\$MN)

Table 30 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By AI & Edge Computing Chips (2023-2034) (\$MN)

Table 31 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By IoT Devices (2023-2034) (\$MN)

Table 32 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Automotive Electronics (2023-2034) (\$MN)

Table 33 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Consumer Electronics (2023-2034) (\$MN)

Table 34 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Industrial Electronics (2023-2034) (\$MN)

Table 35 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By End User (2023-2034) (\$MN)

Table 36 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Semiconductor Manufacturers (2023-2034) (\$MN)

Table 37 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Automotive OEMs (2023-2034) (\$MN)

Table 38 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Consumer Electronics Manufacturers (2023-2034) (\$MN)

Table 39 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Industrial Equipment Manufacturers (2023-2034) (\$MN)

Table 40 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Healthcare Device Manufacturers (2023-2034) (\$MN)

Table 41 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Aerospace & Defense Organizations (2023-2034) (\$MN)

Table 42 Global Embedded Non-Volatile Memory (eNVM) Market Outlook, By Telecommunications Equipment Manufacturers (2023-2034) (\$MN)

Note: Tables for North America, Europe, APAC, South America, and Rest of the World (RoW) are also represented in the same manner as above.

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